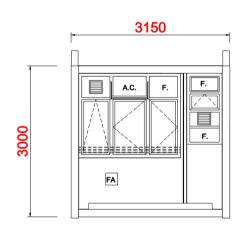
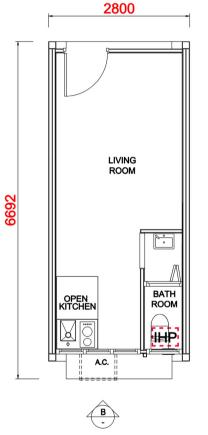


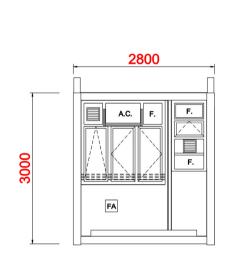
3150



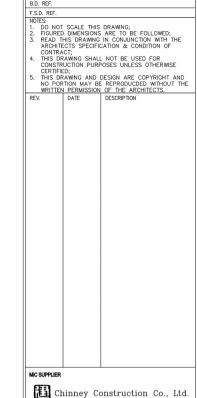
LAYOUT PLAN MODULE NO.: TYPE 01 TYPE 01R (MIRRORED) **ELEVATION A**







ELEVATION B





MiC Holdings (HK) Ltd.

組裝合成建築控股(香港)有限公司

MODULAR INTEGRATED CONSTRUCTION (MIC) SYSTEM:
MICHINNEY-S
(MODEL NO.: CCCL-MIC-S01)

TYPICAL MODULE PLAN FOR MODULE TYPE: 01, 01R, 02 & 02R

DRAWN BY KP	SCALE 1:75 (A3)	
CHECKED BY BF	DATE 2020.10.16	
JOB No. A-2017	DWG.NO. WP-01	REVISION

BD'S OFFICAL USE